

LOOK DOWN IMAGE SENSOR PACKAGE AND FABRICATION METHOD

Paul Robert Hoffman

ABSTRACT

An image sensor package includes a transparent
5 substrate having an image sensor pocket. An image sensor
is flip chip mounted to the transparent substrate such
that the image sensor is located within the image sensor
pocket. Since the image sensor is located within the
image sensor pocket, the image sensor package is
10 approximately the same thickness as the transparent
substrate.

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